

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

μPA1552B

**N-CHANNEL POWER MOS FET ARRAY
SWITCHING USE**

DESCRIPTION

The μPA1552B is N-channel Power MOS FET Array that built in 4 circuits designed, for solenoid, motor and lamp driver.

FEATURES

- 4 V driving is possible
- Large Current and Low On-state Resistance
 $I_{D(DC)} = \pm 5.0 \text{ A}$
 $R_{DS(on)1} \leq 0.18 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 3 \text{ A)}$
 $R_{DS(on)2} \leq 0.24 \Omega \text{ MAX. (} V_{GS} = 4 \text{ V, } I_D = 3 \text{ A)}$
- Low Input Capacitance $C_{iss} = 200 \text{ pF TYP.}$

ORDERING INFORMATION

Type Number	Package
μPA1552BH	10 Pin SIP

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C)

Drain to Source Voltage	V _{DSS} Note 1	60	V
Gate to Source Voltage	V _{GS} Note 2	±20	V
Drain Current (DC)	I _{D(DC)}	±5.0	A/unit
Drain Current (pulse)	I _{D(pulse)} Note 3	±20	A/unit
Total Power Dissipation	P _{T1} Note 4	28	W
Total Power Dissipation	P _{T2} Note 5	3.5	W
Channel Temperature	T _{CH}	150	C
Storage Temperature	T _{stg}	-55 to +150	C
Single Avalanche Current	I _{AS} Note 6	5.0	A
Single Avalanche Energy	E _{AS} Note 6	2.5	mJ

Notes 1. V_{GS} = 0

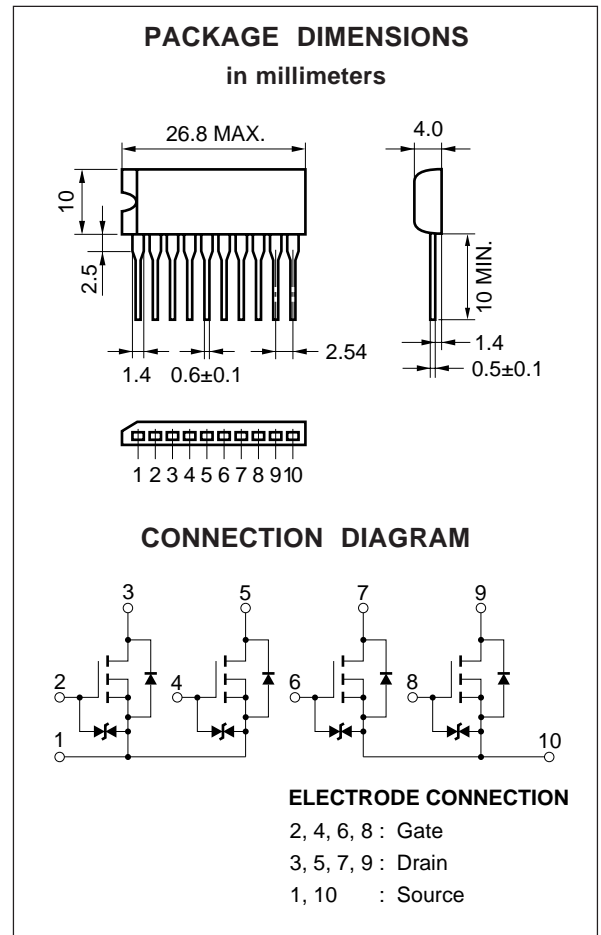
3. PW ≤ 10 μs, Duty Cycle ≤ 1 %

5. 4 Circuits, T_A = 25 °C

2. V_{DS} = 0

4. 4 Circuits, T_C = 25 °C

6. Starting T_{CH} = 25 °C, V_{DD} = 30 V, V_{GS} = 20 V → 0, R_G = 25 Ω, L = 100 μH

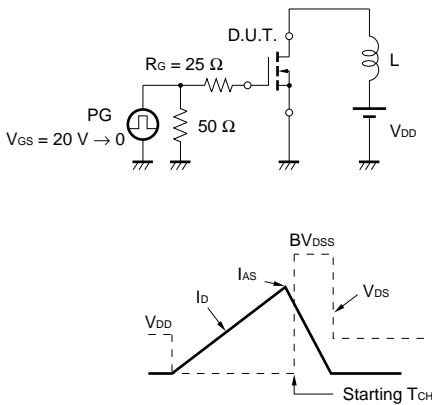


The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

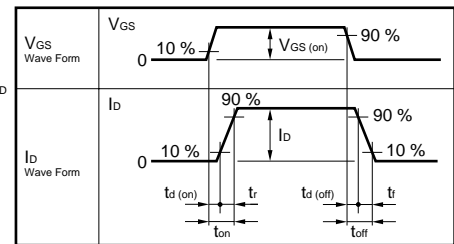
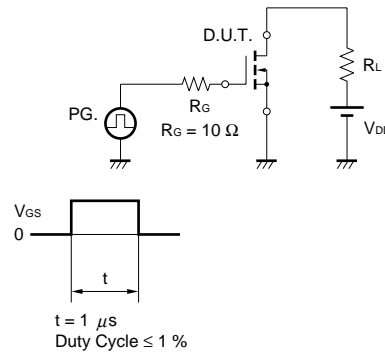
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0			10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0			±10	μA
Gate Cutoff Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1.0 mA	1.0		2.0	V
Forward Transfer Admittance	Y _{fs}	V _{DS} = 10 V, I _D = 3.0 A	2.4			S
Drain to Source On-State Resistance	R _{DS(on)1}	V _{GS} = 10 V, I _D = 3.0 A		0.09	0.18	Ω
	R _{DS(on)2}	V _{GS} = 4.0 V, I _D = 3.0 A		0.12	0.24	Ω
Input Capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0, f = 1.0 MHz		200		pF
Output Capacitance	C _{oss}			150		pF
Reverse Transfer Capacitance	C _{rss}			55		pF
Turn-on Delay Time	t _{d(on)}	I _D = 3.0 A, V _{GS} = 10 V, V _{DD} ≐ 30 V, R _L = 10 Ω		20		ns
Rise Time	t _r			100		ns
Turn-off Delay Time	t _{d(off)}			670		ns
Fall Time	t _f			310		ns
Total Gate Charge	Q _G	V _{GS} = 10 V, I _D = 5.0 A, V _{DD} = 48 V		13		nC
Gate to Source Charge	Q _{GS}			2		nC
Gate to Drain Charge	Q _{GD}			4.7		nC
Body Diode Forward Voltage	V _{F(S-D)}	I _F = 5.0 A, V _{GS} = 0		1.0		V
Reverse Recovery Time	t _{rr}	I _F = 5.0 A, V _{GS} = 0, di/dt = 50 A/μs		280		ns
Reverse Recovery Charge	Q _{rr}			820		nC

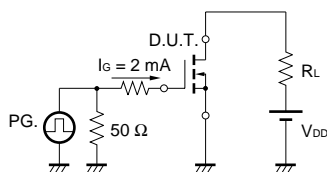
Test Circuit 1 Avalanche Capability



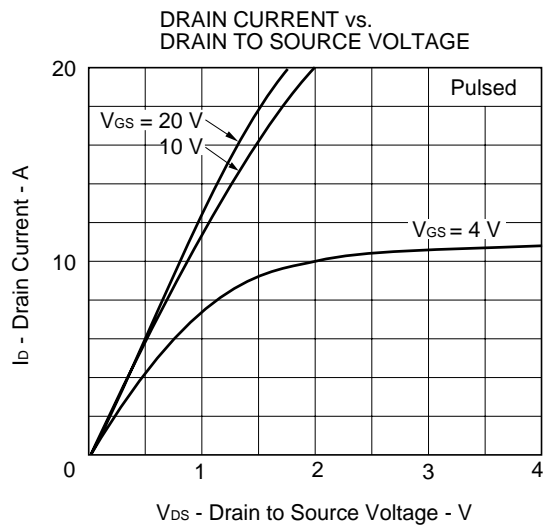
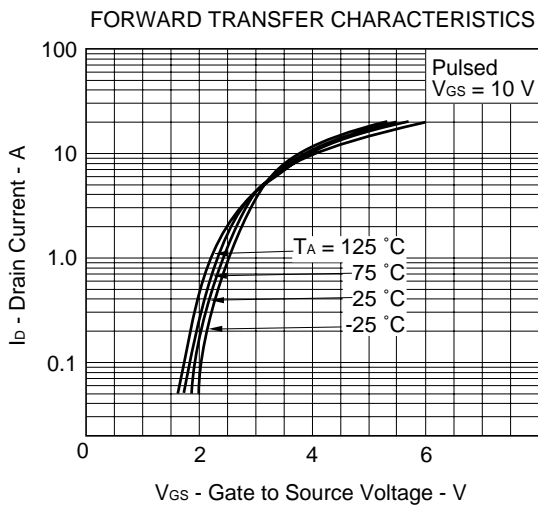
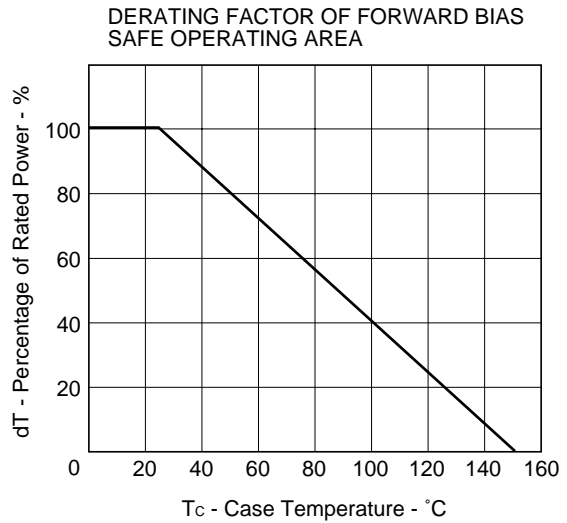
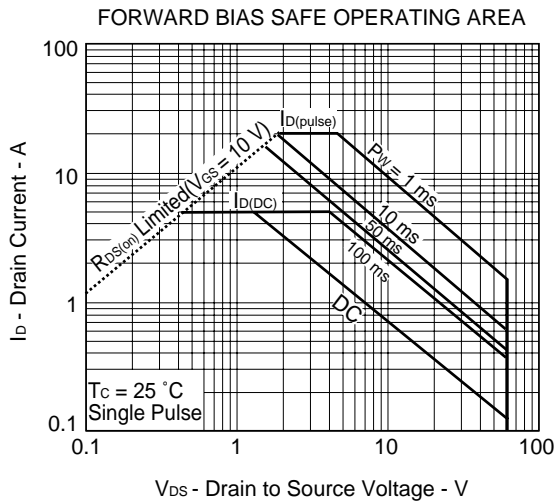
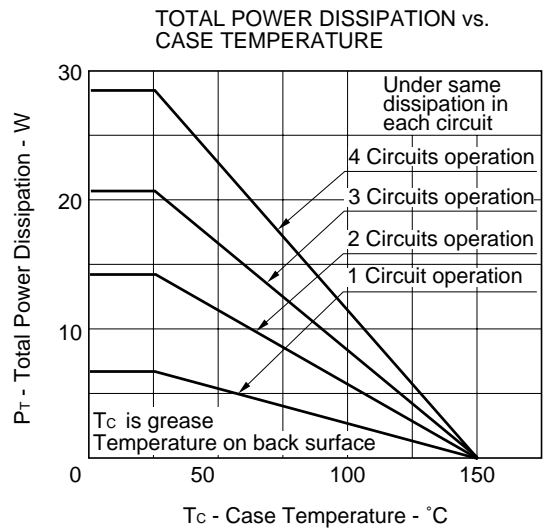
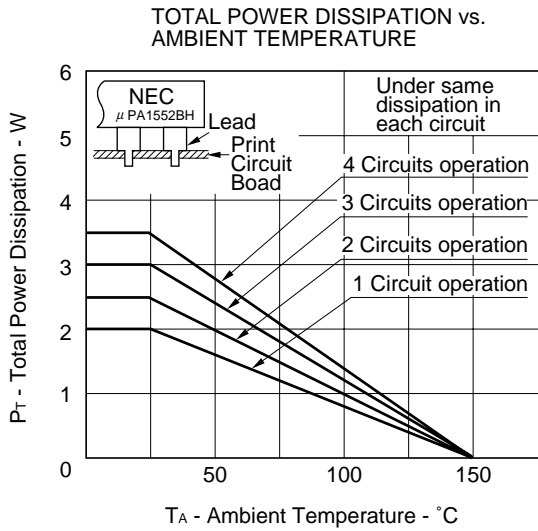
Test Circuit 2 Switching Time



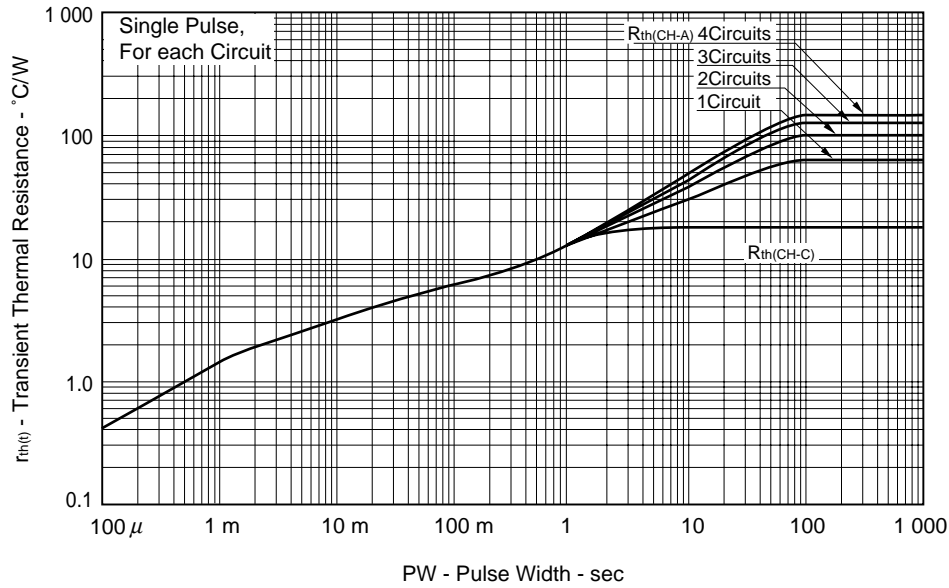
Test Circuit 3 Gate Charge



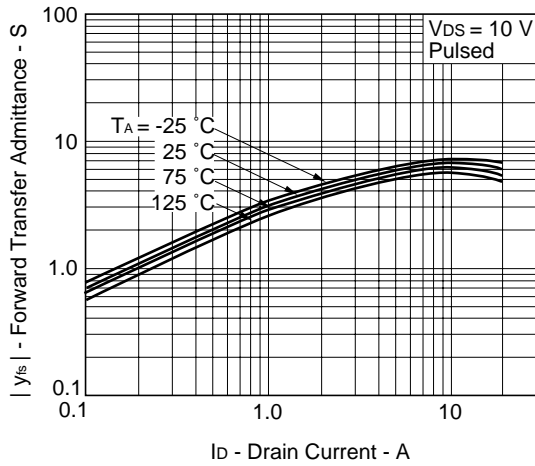
CHARACTERISTICS ($T_A = 25^\circ\text{C}$)



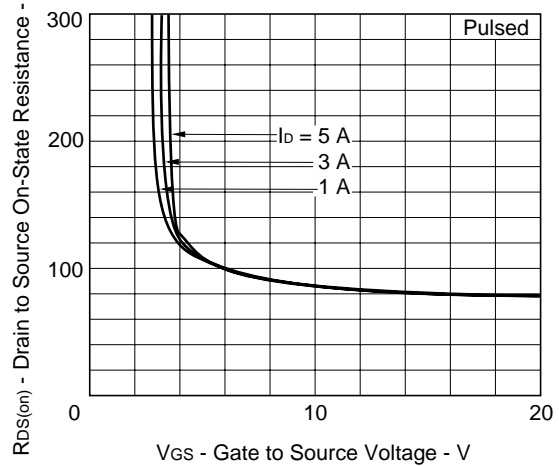
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



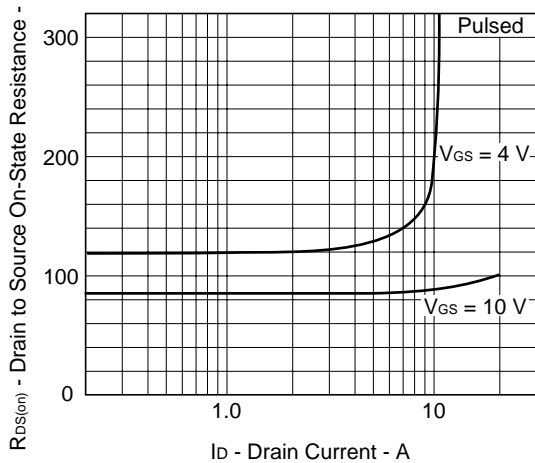
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



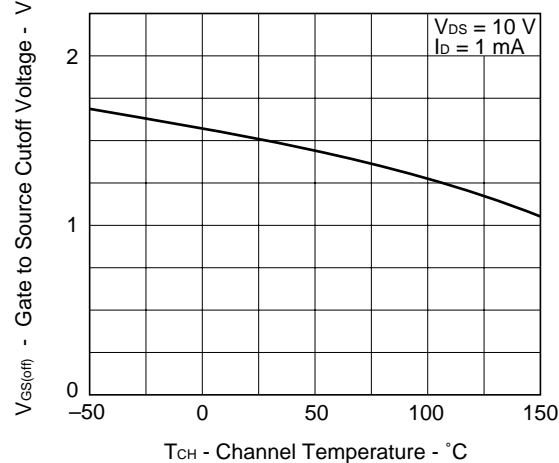
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

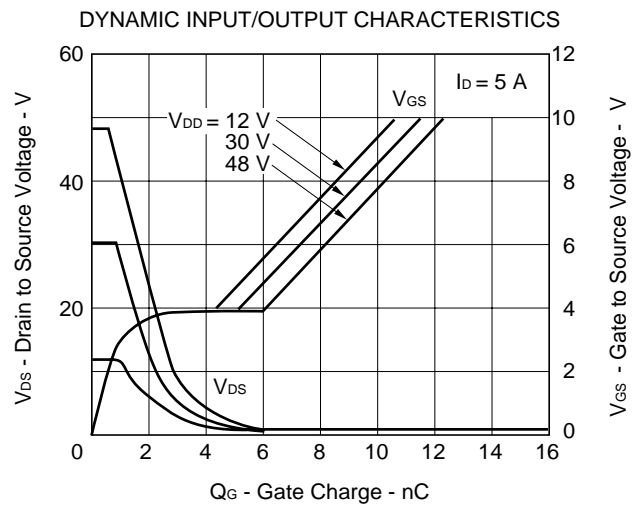
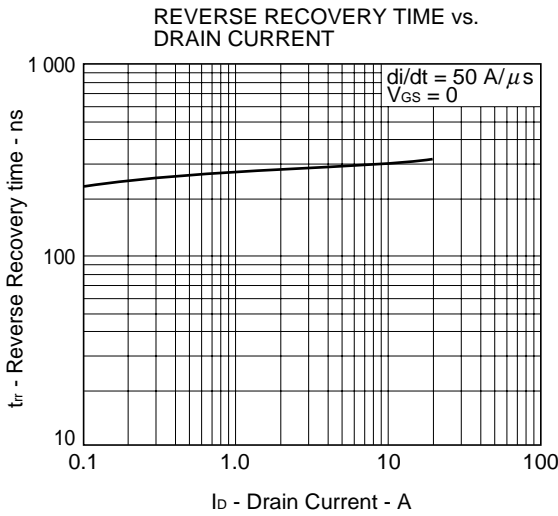
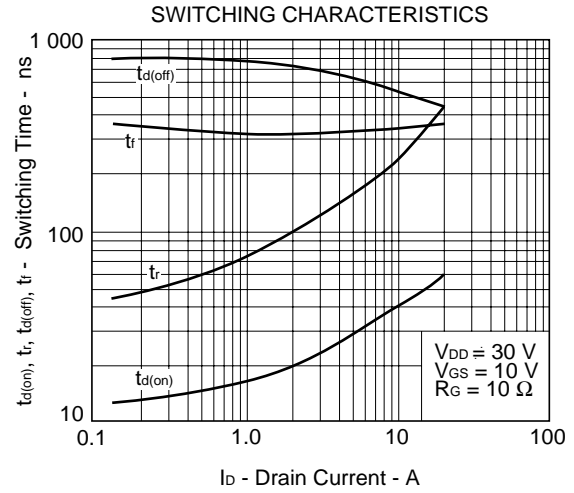
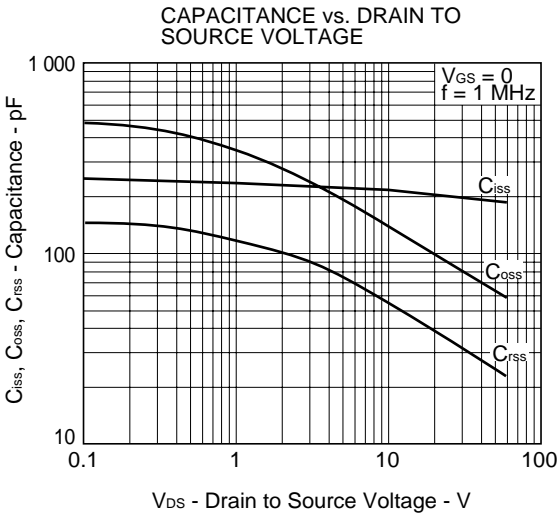
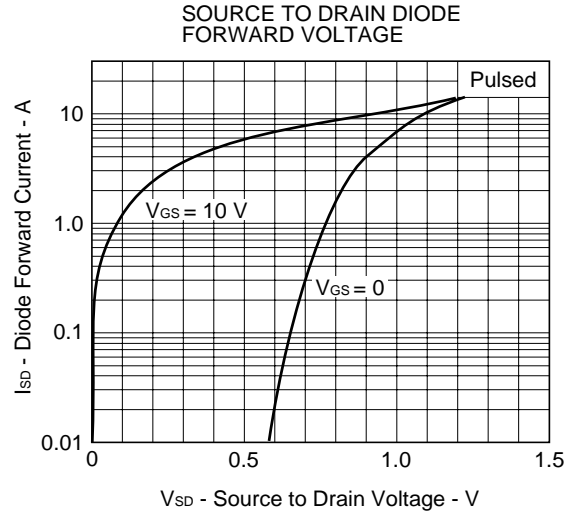
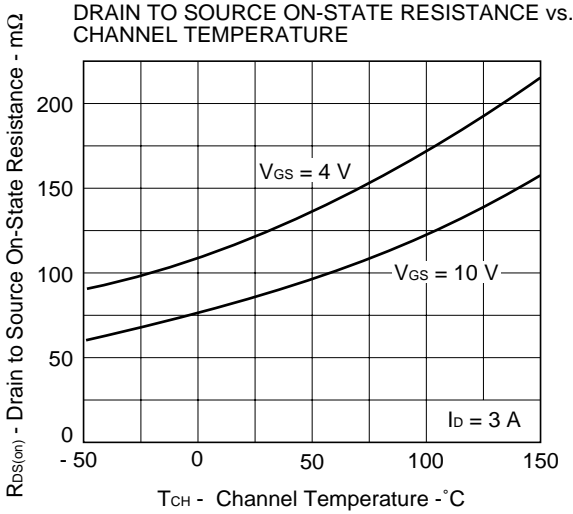


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

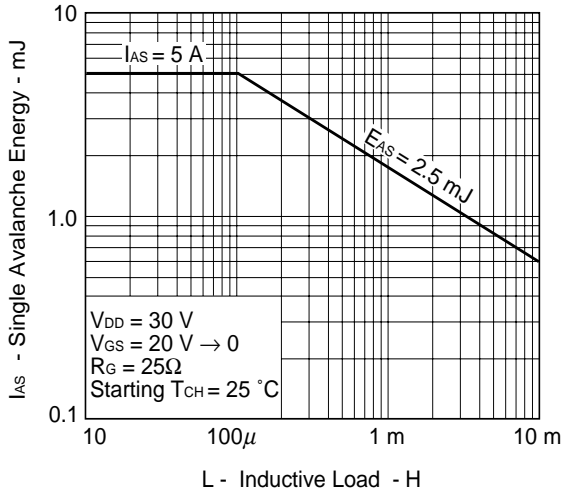


GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

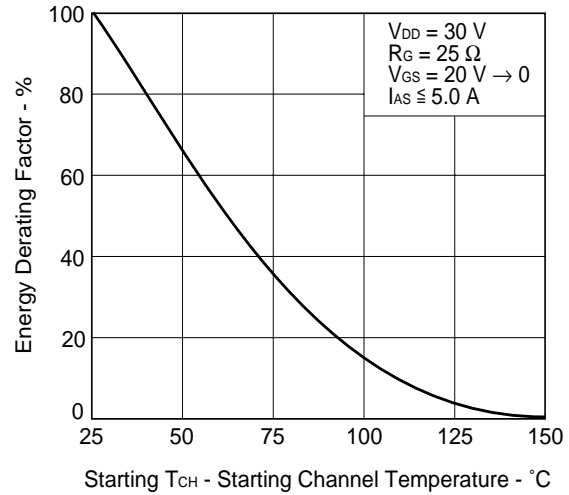




SINGLE AVALANCHE ENERGY vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	IEI-1207
Semiconductor device package manual	IEI-1213
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	MF-1134
Power MOS FET features and application switching power supply	TEA-1034
Application circuits using Power MOS FET	TEA-1035
Safe operating area of Power MOS FET	TEA-1037

[MEMO]

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Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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